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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI
Peripherals	LCD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	176 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	A/D 5x8b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	68-LCC (J-Lead)
Supplier Device Package	68-PLCC (24.23x24.23)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lc924t-04i-l

2.0 PIC16C9XX DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in the PIC16C9XX Product Identification System section at the end of this data sheet. When placing orders, please use that page of the data sheet to specify the correct part number.

For the PIC16C9XX family, there are two device "types" as indicated in the device number:

1. **C**, as in PIC16**C**924. These devices have EPROM type memory and operate over the standard voltage range.
2. **LC**, as in PIC16**LC**924. These devices have EPROM type memory and operate over an extended voltage range.

2.1 UV Erasable Devices

The UV erasable version, offered in CERQUAD package, is optimal for prototype development and pilot programs.

The UV erasable version can be erased and reprogrammed to any of the configuration modes. Microchip's PICSTART® Plus and PRO MATE® II programmers both support the PIC16C9XX. Third party programmers also are available; refer to the *Microchip Third Party Guide* for a list of sources.

2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers who need the flexibility for frequent code updates and small volume applications.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must also be programmed.

2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your local Microchip Technology sales office for more details.

2.4 Serialized Quick-Turnaround Production (SQTPSM) Devices

Microchip offers a unique programming service where a few user-defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential.

Serial programming allows each device to have a unique number which can serve as an entry-code, password or ID number.

3.0 ARCHITECTURAL OVERVIEW

The high performance of the PIC16CXXX family can be attributed to a number of architectural features commonly found in RISC microprocessors. To begin with, the PIC16CXXX uses a Harvard architecture, in which, program and data are accessed from separate memories using separate buses. This improves bandwidth over traditional von Neumann architecture where program and data are fetched from the same memory using the same bus. Separating program and data buses further allows instructions to be sized differently than the 8-bit wide data word. Instruction opcodes are 14-bits wide making it possible to have all single word instructions. A 14-bit wide program memory access bus fetches a 14-bit instruction in a single cycle. A two-stage pipeline overlaps fetch and execution of instructions (Example 3-1). Consequently, all instructions execute in a single cycle (500 ns @ 8 MHz) except for program branches.

The PIC16C923 and PIC16C924 both address 4K x 14 of program memory and 176 x 8 of data memory.

The PIC16CXXX can directly or indirectly address its register files or data memory. All special function registers, including the program counter, are mapped in the data memory. The PIC16CXXX has an orthogonal (symmetrical) instruction set that makes it possible to carry out any operation on any register using any addressing mode. This symmetrical nature and lack of 'special optimal situations' make programming with the PIC16CXXX simple yet efficient, thus significantly reducing the learning curve.

PIC16CXXX devices contain an 8-bit ALU and working register. The ALU is a general purpose arithmetic unit. It performs arithmetic and Boolean functions between the data in the working register and any register file.

The ALU is 8-bits wide and capable of addition, subtraction, shift and logical operations. Unless otherwise mentioned, arithmetic operations are two's complement in nature. In two-operand instructions, typically one operand is the working register (W register). The other operand is a file register or an immediate constant. In single operand instructions, the operand is either the W register or a file register.

The W register is an 8-bit working register used for ALU operations. It is not an addressable register.

Depending on the instruction executed, the ALU may affect the values of the Carry (C), Digit Carry (DC), and Zero (Z) bits in the STATUS register. The C and DC bits operate as a borrow bit and a digit borrow out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

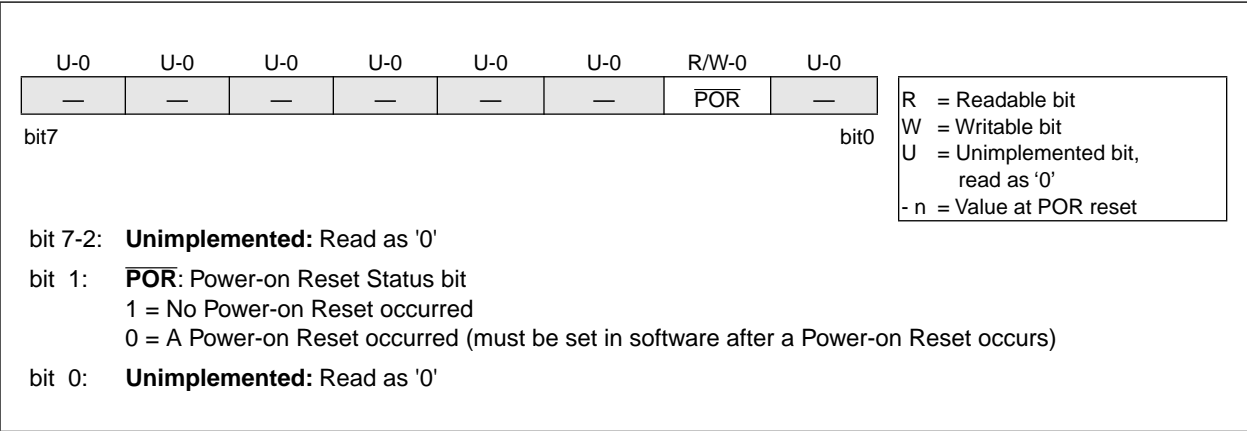
PIC16C9XX

4.2.2.6 PCON REGISTER

For various reset conditions see Table 14-4 and Table 14-5.

The Power Control (PCON) register contains a flag bit to allow differentiation between a Power-on Reset (POR) to an external $\overline{\text{MCLR}}$ Reset or WDT Reset.

FIGURE 4-8: PCON REGISTER (ADDRESS 8Eh)



6.0 OVERVIEW OF TIMER MODULES

Each module can generate an interrupt to indicate that an event has occurred (e.g. timer overflow). Each of these modules is explained in full detail in the following sections. The timer modules are:

- Timer0 Module (Section 7.0)
- Timer1 Module (Section 8.0)
- Timer2 Module (Section 9.0)

6.1 Timer0 Overview

The Timer0 module is a simple 8-bit timer/counter. The clock source can be either the internal system clock ($F_{osc}/4$) or an external clock. When the clock source is an external clock, the Timer0 module can be selected to increment on either the rising or falling edge.

The Timer0 module also has a programmable prescaler option. This prescaler can be assigned to either the Timer0 module or the Watchdog Timer. Bit PSA ($OPTION<3>$) assigns the prescaler, and bits PS2:PS0 ($OPTION<2:0>$) determine the prescaler value. Timer0 can increment at the following rates: 1:1 when prescaler assigned to Watchdog timer, 1:2, 1:4, 1:8, 1:16, 1:32, 1:64, 1:128, and 1:256.

Synchronization of the external clock occurs after the prescaler. When the prescaler is used, the external clock frequency may be higher than the device's frequency. The maximum frequency is 50 MHz, given the high and low time requirements of the clock.

6.2 Timer1 Overview

Timer1 is a 16-bit timer/counter. The clock source can be either the internal system clock ($F_{osc}/4$), an external clock, or an external crystal. Timer1 can operate as either a timer or a counter. When operating as a counter (external clock source), the counter can either operate synchronized to the device or asynchronously to the device. Asynchronous operation allows Timer1 to operate during sleep, which is useful for applications that require a real-time clock as well as the power savings of SLEEP mode.

Timer1 also has a prescaler option which allows Timer1 to increment at the following rates: 1:1, 1:2, 1:4, and 1:8. Timer1 can be used in conjunction with the Capture/Compare/PWM module. When used with a CCP module, Timer1 is the time-base for 16-bit capture or the 16-bit compare and must be synchronized to the device. Timer1 oscillator is also one of the clock sources for the LCD module.

6.3 Timer2 Overview

Timer2 is an 8-bit timer with a programmable prescaler and postscaler, as well as an 8-bit period register (PR2). Timer2 can be used with the CCP1 module (in PWM mode) as well as the clock source for the Syn-

chronous Serial Port (SSP). The prescaler option allows Timer2 to increment at the following rates: 1:1, 1:4, 1:16.

The postscaler allows the TMR2 register to match the period register (PR2) a programmable number of times before generating an interrupt. The postscaler can be programmed from 1:1 to 1:16 (inclusive).

6.4 CCP Overview

The CCP module can operate in one of these three modes: 16-bit capture, 16-bit compare, or up to 10-bit Pulse Width Modulation (PWM).

Capture mode captures the 16-bit value of TMR1 into the CCPR1H:CCPR1L register pair. The capture event can be programmed for either the falling edge, rising edge, fourth rising edge, or the sixteenth rising edge of the CCP1 pin.

Compare mode compares the TMR1H:TMR1L register pair to the CCPR1H:CCPR1L register pair. When a match occurs an interrupt can be generated, and the output pin CCP1 can be forced to given state (High or Low), TMR1 can be reset and start A/D conversion. This depends on the control bits CCP1M3:CCP1M0.

PWM mode compares the TMR2 register to a 10-bit duty cycle register (CCPR1H:CCPR1L<5:4>) as well as to an 8-bit period register (PR2). When the TMR2 register = Duty Cycle register, the CCP1 pin will be forced low. When $TMR2 = PR2$, TMR2 is cleared to 00h, an interrupt can be generated, and the CCP1 pin (if an output) will be forced high.

11.0 SYNCHRONOUS SERIAL PORT (SSP) MODULE

The Synchronous Serial Port (SSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, dis-

play drivers, A/D converters, etc. The SSP module can operate in one of two modes:

- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I²C)

Refer to Application Note AN578, "Use of the SSP Module in the I²C Multi-Master Environment."

FIGURE 11-1: SSPSTAT: SYNC SERIAL PORT STATUS REGISTER (ADDRESS 94h)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE	D/A	P	S	R/W	UA	BF
bit7							bit0
<p>bit 7: SMP: SPI data input sample phase <u>SPI Master Mode</u> 1 = Input data sampled at end of data output time 0 = Input data sampled at middle of data output time <u>SPI Slave Mode</u> SMP must be cleared when SPI is used in slave mode</p> <p>bit 6: CKE: SPI Clock Edge Select (Figure 11-5, Figure 11-6, and Figure 11-7) <u>CKP = 0</u> 1 = Data transmitted on rising edge of SCK 0 = Data transmitted on falling edge of SCK <u>CKP = 1</u> 1 = Data transmitted on falling edge of SCK 0 = Data transmitted on rising edge of SCK</p> <p>bit 5: D/A: Data/Address bit (I²C mode only) 1 = Indicates that the last byte received or transmitted was data 0 = Indicates that the last byte received or transmitted was address</p> <p>bit 4: P: Stop bit (I²C mode only. This bit is cleared when the SSP module is disabled, or when the Start bit was detected last) 1 = Indicates that a stop bit has been detected last (this bit is '0' on RESET) 0 = Stop bit was not detected last</p> <p>bit 3: S: Start bit (I²C mode only. This bit is cleared when the SSP module is disabled, or when the Stop bit was detected last) 1 = Indicates that a start bit has been detected last (this bit is '0' on RESET) 0 = Start bit was not detected last</p> <p>bit 2: R/W: Read/Write bit information (I²C mode only) This bit holds the R/W bit information following the last address match. This bit is only valid from the address match to the next start bit, stop bit, or $\overline{\text{ACK}}$ bit. 1 = Read 0 = Write</p> <p>bit 1: UA: Update Address (10-bit I²C mode only) 1 = Indicates that the user needs to update the address in the SSPADD register 0 = Address does not need to be updated</p> <p>bit 0: BF: Buffer Full Status bit <u>Receive</u> (SPI and I²C modes) 1 = Receive complete, SSPBUF is full 0 = Receive not complete, SSPBUF is empty <u>Transmit</u> (I²C mode only) 1 = Transmit in progress, SSPBUF is full 0 = Transmit complete, SSPBUF is empty</p>							

R = Readable bit
 W = Writable bit
 U = Unimplemented bit,
 read as '0'
 - n = Value at POR reset

12.8 Use of the CCP Trigger

An A/D conversion can be started by the “special event trigger” of the CCP1 module. This requires that the CCP1M3:CCP1M0 bits (CCP1CON<3:0>) be programmed as 1011 and that the A/D module is enabled (ADON bit is set). When the trigger occurs, the GO/DONE bit will be set, starting the A/D conversion, and the Timer1 counter will be reset to zero. Timer1 is reset to automatically repeat the A/D acquisition period with minimal software overhead (moving the ADRES to the desired location). The appropriate analog input channel must be selected and the minimum acquisition done before the “special event trigger” sets the GO/DONE bit (starts a conversion).

If the A/D module is not enabled (ADON is cleared), then the “special event trigger” will be ignored by the A/D module, but will still reset the Timer1 counter.

12.9 Connection Considerations

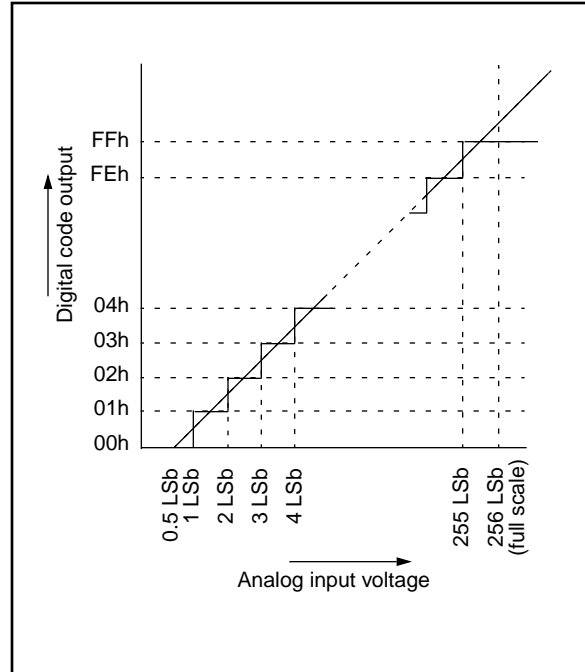
If the input voltage exceeds the rail values (VSS or VDD) by greater than 0.2V, then the accuracy of the conversion is out of specification.

An external RC filter is sometimes added for anti-aliasing of the input signal. The R component should be selected to ensure that the total source impedance is kept under the 10 kΩ recommended specification. Any external components connected (via hi-impedance) to an analog input pin (capacitor, zener diode, etc.) should have very little leakage current at the pin.

12.10 Transfer Function

The ideal transfer function of the A/D converter is as follows: the first transition occurs when the analog input voltage (VAIN) is Analog VREF / 256 (Figure 12-5).

FIGURE 12-5: A/D TRANSFER FUNCTION



13.4 Operation During Sleep

The LCD module can operate during sleep. The selection is controlled by bit SLPEN (LCDCON<6>). Setting the SLPEN bit allows the LCD module to go to sleep. Clearing the SLPEN bit allows the module to continue to operate during sleep.

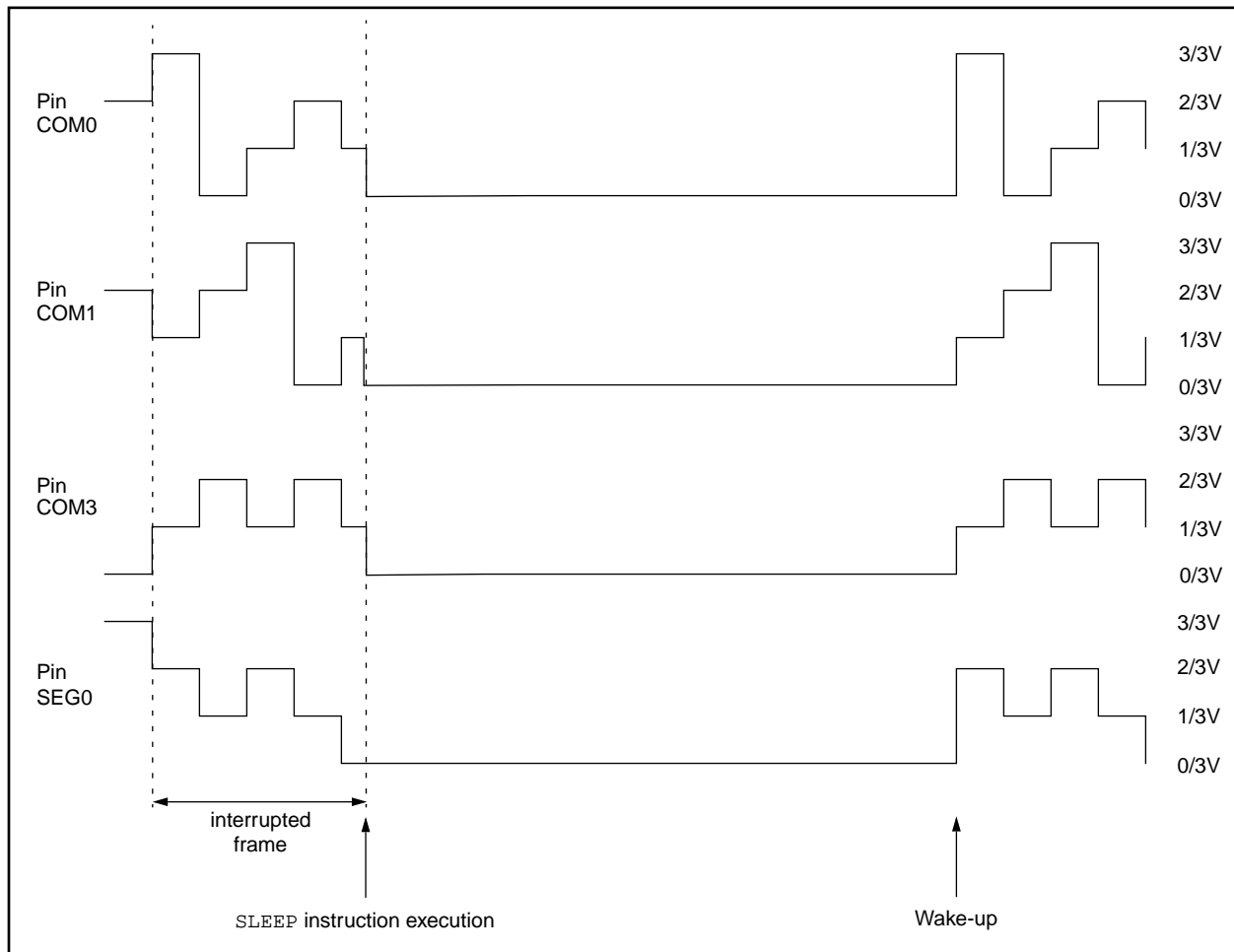
If a **SLEEP** instruction is executed and SLPEN = '1', the LCD module will cease all functions and go into a very low current consumption mode. The module will stop operation immediately and drive the minimum LCD voltage on both segment and common lines. Figure 13-11 shows this operation. To ensure that the LCD completes the frame, the **SLEEP** instruction should be executed immediately after a LCD frame boundary.

The LCD interrupt can be used to determine the frame boundary. See Section 13.2 for the formulas to calculate the delay.

If a **SLEEP** instruction is executed and SLPEN = '0', the module will continue to display the current contents of the LCDD registers. To allow the module to continue operation while in sleep, the clock source must be either the internal RC oscillator or Timer1 external oscillator. While in sleep, the LCD data cannot be changed. The LCD module current consumption will not decrease in this mode, however the overall consumption of the device will be lower due to shutdown of the core and other peripheral functions.

Note: The internal RC oscillator or external Timer1 oscillator must be used to operate the LCD module during sleep.

FIGURE 13-11: SLEEP ENTRY/EXIT WHEN SLPEN = 1 OR CS1:CS0 = 00



13.5 Voltage Generation

There are two methods for LCD voltage generation, internal charge pump, or external resistor ladder.

13.5.1 CHARGE PUMP

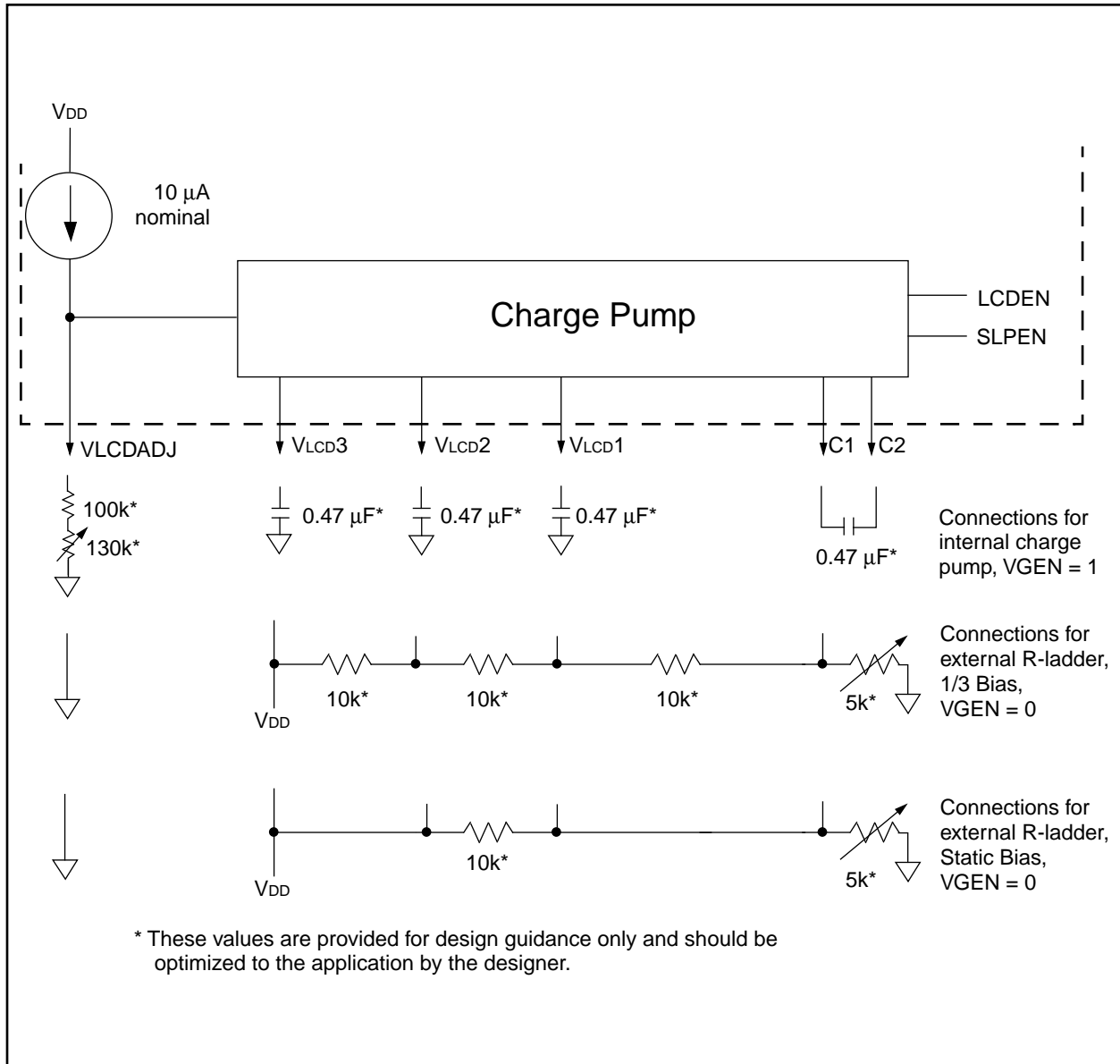
The LCD charge pump is shown in Figure 13-13. The 1.0V - 2.3V regulator will establish a stable base voltage from the varying battery voltage. This regulator is adjustable through the range by connecting a variable external resistor from VLCDADJ to ground. The potentiometer provides contrast adjustment for the LCD. This base voltage is connected to VLCD1 on the charge pump. The charge pump boosts VLCD1 into VLCD2 =

$2 \times V_{LCD1}$ and $V_{LCD3} = 3 \times V_{LCD1}$. When the charge pump is not operating, VLCD3 will be internally tied to VDD. See the Electrical Specifications section for charge pump capacitor and potentiometer values.

13.5.2 EXTERNAL R-LADDER

The LCD module can also use an external resistor ladder (R-Ladder) to generate the LCD voltages. Figure 13-13 shows external connections for static and 1/3 bias. The VGEN (LCDCON<4>) bit must be cleared to use an external R-Ladder.

FIGURE 13-13:CHARGE PUMP AND RESISTOR LADDER



14.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC16CXXX family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- Oscillator selection
- Reset
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code protection
- ID locations
- In-circuit serial programming

The PIC16CXXX has a Watchdog Timer which can be shut off only through configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is

the Oscillator Start-up Timer (OST), intended to keep the chip in reset until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

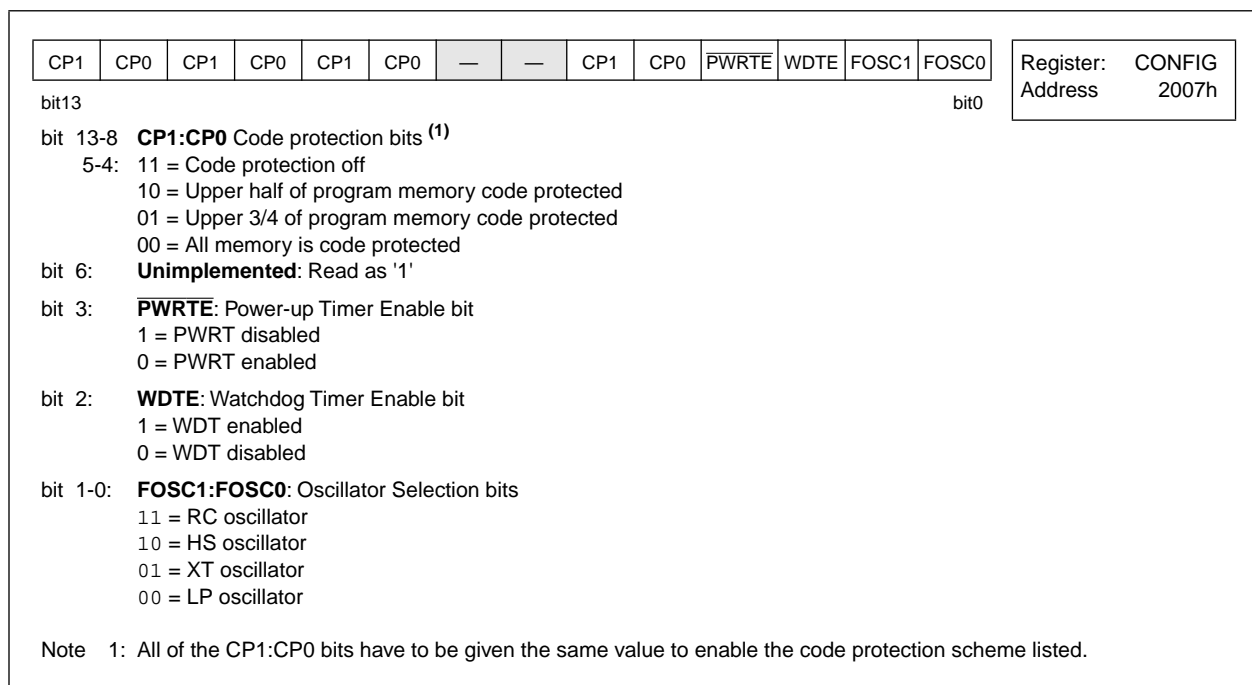
SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external reset, Watchdog Timer Wake-up or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The RC oscillator option saves system cost while the LP crystal option saves power. A set of configuration bits are used to select various options.

14.1 Configuration Bits

The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h - 3FFFh), which can be accessed only during programming.

FIGURE 14-1: CONFIGURATION WORD



14.4 Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)

14.4.1 POWER-ON RESET (POR)

A Power-on Reset pulse is generated on-chip when VDD rise is detected (in the range of 1.5V - 2.1V). To take advantage of the POR, just tie the $\overline{\text{MCLR}}$ pin directly (or through a resistor) to VDD. This will eliminate external RC components usually needed to create a Power-on Reset. A maximum rise time for VDD is specified. See Electrical Specifications for details.

When the device starts normal operation (exits the reset condition), device operating parameters (voltage, frequency, temperature, ...) must be met to ensure operation. If these conditions are not met, the device must be held in reset until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting."

14.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms nominal time-out on power-up only, from the POR. The Power-up Timer operates on an internal RC oscillator. The chip is kept in reset as long as the PWRT is active. The PWRT's time delay allows VDD to rise to an acceptable level. A configuration bit is provided to enable/disable the PWRT.

The power-up time delay will vary from chip to chip due to VDD, temperature, and process variation. See DC parameters for details.

14.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-up Timer (OST) provides 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

14.4.4 TIME-OUT SEQUENCE

On power-up the time-out sequence is as follows: First PWRT time-out is invoked after the POR time delay has expired. Then OST is activated. The total time-out will vary based on oscillator configuration and the status of the PWRT. For example, in RC mode with the PWRT disabled, there will be no time-out at all. Figure 14-8, Figure 14-9, and Figure 14-10 depict time-out sequences on power-up.

Since the time-outs occur from the POR pulse, if $\overline{\text{MCLR}}$ is kept low long enough, the time-outs will expire. Then bringing $\overline{\text{MCLR}}$ high will begin execution immediately (Figure 14-9). This is useful for testing purposes or to synchronize more than one PIC16CXXX device operating in parallel.

Table 14-5 shows the reset conditions for some special function registers, while Table 14-6 shows the reset conditions for all the registers.

14.4.5 POWER CONTROL/STATUS REGISTER (PCON)

Bit1 is Power-on Reset Status bit $\overline{\text{POR}}$. It is cleared on a Power-on Reset and unaffected otherwise. The user must set this bit following a Power-on Reset.

TABLE 14-3: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	Power-up		Wake-up from SLEEP
	PWRT = 1	PWRT = 0	
XT, HS, LP	1024Tosc	72 ms + 1024Tosc	1024 Tosc
RC	—	72 ms	—

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INCF	Increment f								
Syntax:	[<i>label</i>] INCF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	$(f) + 1 \rightarrow (\text{destination})$								
Status Affected:	Z								
Encoding:	<table><tr><td>00</td><td>1010</td><td>dfff</td><td>ffff</td></tr></table>	00	1010	dfff	ffff				
00	1010	dfff	ffff						
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.								
Words:	1								
Cycles:	1								
Q Cycle Activity:	<table><tr><th>Q1</th><th>Q2</th><th>Q3</th><th>Q4</th></tr><tr><td>Decode</td><td>Read register 'f'</td><td>Process data</td><td>Write to destination</td></tr></table>	Q1	Q2	Q3	Q4	Decode	Read register 'f'	Process data	Write to destination
Q1	Q2	Q3	Q4						
Decode	Read register 'f'	Process data	Write to destination						

Example

```
INCF    CNT, 1
```

Before Instruction

```
CNT    = 0xFF
Z      = 0
```

After Instruction

```
CNT    = 0x00
Z      = 1
```

INCFSZ	Increment f, Skip if 0			
Syntax:	[<i>label</i>] INCFSZ f,d			
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$			
Operation:	$(f) + 1 \rightarrow (\text{destination})$, skip if result = 0			
Status Affected:	None			
Encoding:	00	1111	dfff	ffff
Description:	The contents of register 'f' are incremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'. If the result is 1, the next instruction is executed. If the result is 0, a NOP is executed instead making it a 2Tcy instruction.			
Words:	1			
Cycles:	1(2)			
Q Cycle Activity:	Q1	Q2	Q3	Q4

If Skip: (2nd Cycle)

Q1	Q2	Q3	Q4
No-Operation	No-Operation	No-Operation	No-Operation

Example

```
HERE    INCFSZ    CNT, 1
        GOTO     LOOP
CONTINUE •
        •
        •
```

Before Instruction

```
PC    = address HERE
```

After Instruction

```
CNT    = CNT + 1
if CNT = 0,
PC     = address CONTINUE
if CNT ≠ 0,
PC     = address HERE + 1
```

PIC16C9XX

XORLW Exclusive OR Literal with W

Syntax: `[label] XORLW k`

Operands: $0 \leq k \leq 255$

Operation: $(W) \text{ .XOR. } k \rightarrow (W)$

Status Affected: Z

Encoding:

11	1010	kkkk	kkkk
----	------	------	------

Description: The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process data	Write to W

Example: `XORLW 0xAF`

Before Instruction

`W = 0xB5`

After Instruction

`W = 0x1A`

XORWF Exclusive OR W with f

Syntax: `[label] XORWF f,d`

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) \text{ .XOR. } (f) \rightarrow (\text{destination})$

Status Affected: Z

Encoding:

00	0110	dfff	ffff
----	------	------	------

Description: Exclusive OR the contents of the W register with register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process data	Write to destination

Example `XORWF REG 1`

Before Instruction

`REG = 0xAF`
`W = 0xB5`

After Instruction

`REG = 0x1A`
`W = 0xB5`

PIC16C9XX

TABLE 16-1: DEVELOPMENT TOOLS FROM MICROCHIP

	PIC12C5XX	PIC14000	PIC16C5X	PIC16CXXX	PIC16C6X	PIC16C7XX	PIC16C8X	PIC16C9XX	PIC17C4X	PIC17C75X	24CXX 25CXX 93CXX	HCS200 HCS300 HCS301
Emulator Products												
PICMASTER [®] / PICMASTER-CE In-Circuit Emulator	✓	✓	✓	✓	✓	✓	✓	✓	✓	Available 3Q97		
ICEPIC Low-Cost In-Circuit Emulator	✓		✓	✓	✓	✓	✓					
Software Tools												
MPLAB [™] Integrated Development Environment	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		
MPLAB [™] C Compiler	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		
fuzzyTECH [®] -MP Explorer/Edition Fuzzy Logic Dev. Tool	✓	✓	✓	✓	✓	✓	✓	✓	✓			
MP-DriveWay [™] Applications Code Generator			✓	✓	✓	✓	✓	✓	✓			
Total Endurance [™] Software Model			✓	✓	✓	✓	✓		✓		✓	
Programmers												
PICSTART [®] Lite Ultra Low-Cost Dev. Kit			✓		✓	✓	✓					
PICSTART [®] Plus Low-Cost Universal Dev. Kit	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		
PRO MATE [®] II Universal Programmer	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	
KEELOQ [®] Programmer												✓
SEEVAL [®] Designers Kit												
Demo Boards												
PICDEM-1			✓	✓			✓		✓			
PICDEM-2					✓	✓						
PICDEM-3								✓				
KEELOQ [®] Evaluation Kit												✓

17.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

Ambient temperature under bias	-55°C to +125°C
Storage temperature	-65°C to +150°C
Voltage on any pin with respect to VSS (except VDD, $\overline{\text{MCLR}}$, and RA4).....	-0.3V to (VDD + 0.3V)
Voltage on VDD with respect to VSS	-0.3V to +7.5V
Voltage on $\overline{\text{MCLR}}$ with respect to VSS.....	0V to +14V
Voltage on RA4 with respect to VSS	0V to +14V
Total power dissipation (Note 1).....	1.0W
Maximum current out of VSS pin	300 mA
Maximum current into VDD pin	250 mA
Input clamp current, I _{IK} (V _I < 0 or V _I > VDD).....	± 20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > VDD).....	± 20 mA
Maximum output current sunk by any I/O pin	10 mA
Maximum output current sourced by any I/O pin	10 mA
Maximum current sunk by all Ports combined	200 mA
Maximum current sourced by all Ports combined	200 mA

Note 1: Power dissipation is calculated as follows: $P_{DIS} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$

† NOTICE: Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 17-1: CROSS REFERENCE OF DEVICE SPECS FOR OSCILLATOR CONFIGURATIONS AND FREQUENCIES OF OPERATION (COMMERCIAL DEVICES)

OSC	PIC16C923-04 PIC16C924-04	PIC16C923-08 PIC16C924-08	PIC16LC923-04 PIC16LC924-04	CL Devices
RC	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
XT	VDD: 4.0V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 2.7 mA typ. at 5.5V IPD: 1.5 µA typ. at 4V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 3.8 mA max. at 3.0V IPD: 5 µA max. at 3V Freq: 4 MHz max.	VDD: 2.5V to 6.0V IDD: 5 mA max. at 5.5V IPD: 21 µA max. at 4V Freq: 4 MHz max.
HS	VDD: 4.5V to 5.5V IDD: 3.5 mA typ. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 4 MHz max.	VDD: 4.5V to 5.5V IDD: 7 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 8 MHz max.	Do not use in HS mode	VDD: 4.5V to 5.5V IDD: 7 mA max. at 5.5V IPD: 1.5 µA typ. at 4.5V Freq: 8 MHz max.
LP	VDD: 4.0V to 6.0V IDD: 22.5 µA typ. at 32 kHz, 4.0V IPD: 1.5 µA typ. at 4.0V Freq: 200 kHz max.	Do not use in LP mode	VDD: 2.5V to 6.0V IDD: 30 µA max. at 32 kHz, 3.0V IPD: 5 µA max. at 3.0V Freq: 200 kHz max.	VDD: 2.5V to 6.0V IDD: 30 µA max. at 32 kHz, 3.0V IPD: 5 µA max. at 3.0V Freq: 200 kHz max.

The shaded sections indicate oscillator selections which are tested for functionality, but not for MIN/MAX specifications. It is recommended that the user select the device type that ensures the specifications required.

17.2 DC Characteristics:

PIC16LC923/924-04 (Commercial, Industrial)

DC CHARACTERISTICS							Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D001	Supply Voltage	VDD	2.5	-	6.0	V	LP, XT, RC osc configuration
D002*	RAM Data Retention Voltage (Note 1)	VDR	-	1.5	-	V	
D003	VDD start voltage to ensure internal Power-on Reset signal	VPOR	-	VSS	-	V	See Power-on Reset section for details
D004*	VDD rise rate to ensure internal Power-on Reset signal	SVDD	0.05	-	-	V/ms	(Note 6) See Power-on Reset section for details
D010	Supply Current (Note 2)	IDD	-	2.0	3.8	mA	XT and RC osc configuration FOSC = 4 MHz, VDD = 3.0V (Note 4)
D011				13.5	30	μA	LP osc configuration, FOSC = 32 kHz, VDD = 4.0V
D020	Power-down Current (Note 3)	IPD	-	0.9	5	μA	VDD = 3.0V
D021	Module Differential Current (Note 5)	ΔIWD	-	6.0	20	μA	VDD = 3.0V
D022*	Watchdog Timer	ΔIWD	-	36	50	μA	VDD = 3.0V (Note 7)
D024*	LCD Voltage Generation w/internal RC osc enabled	ΔILCDRC	-	15	29	μA	VDD = 3.0V (Note 7)
D025*	LCD Voltage Generation w/Timer1 @ 32.768 kHz	ΔILCDT1	-	3.1	6.5	μA	VDD = 3.0V
D026*	Timer1 oscillator	ΔIT1OSC	-	1.0	-	μA	A/D on, not converting
D026*	A/D Converter	ΔIAD	-	-	-	μA	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD

MCLR = VDD.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_r = VDD/2R_{ext}$ (mA) with Rext in kOhm.

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

6: PWRT must be enabled for slow ramps.

7: ΔILCDT1 and ΔILCDRC includes the current consumed by the LCD Module and the voltage generation circuitry. This does not include current dissipated by the LCD panel.

FIGURE 17-2: LOAD CONDITIONS

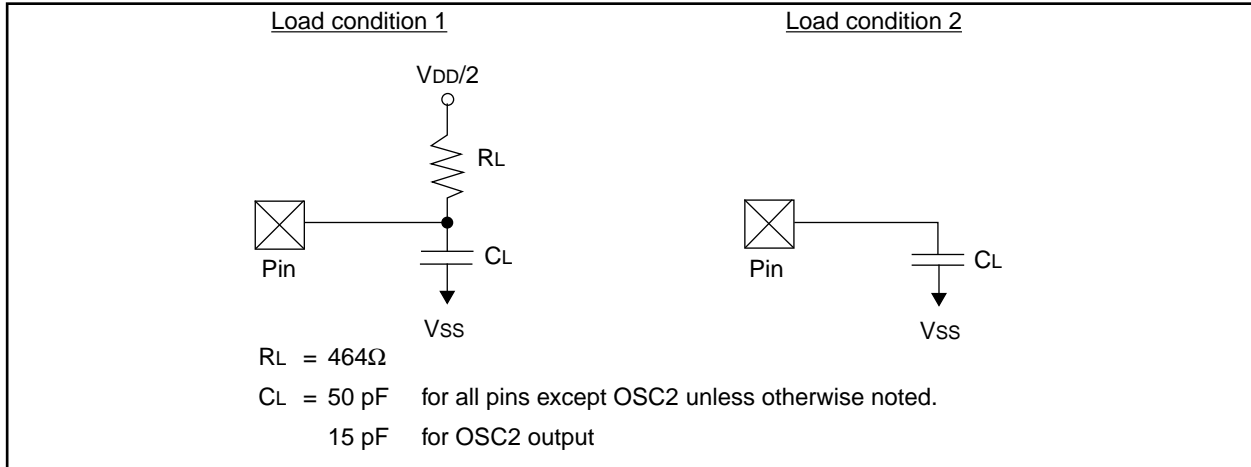


FIGURE 17-6: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS

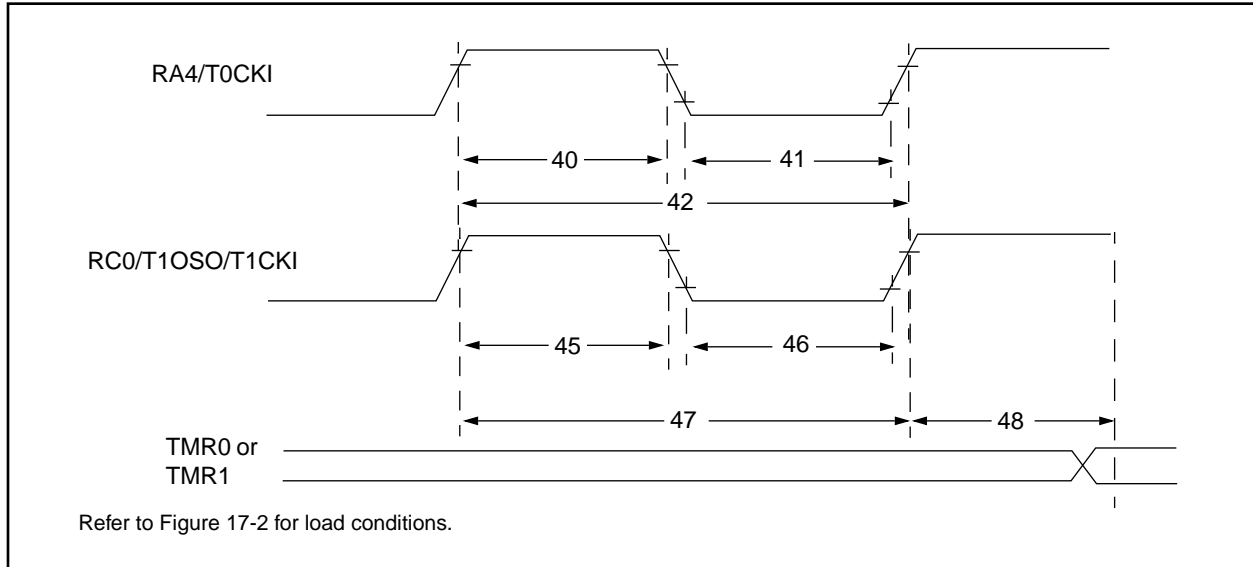


TABLE 17-7: TIMER0 AND TIMER1 EXTERNAL CLOCK REQUIREMENTS

Param No.	Sym	Characteristic			Min	Typ†	Max	Units	Conditions
40*	Tt0H	T0CKI High Pulse Width		No Prescaler	0.5TCY + 20	—	—	ns	Must also meet parameter 42
				With Prescaler	10	—	—	ns	
41*	Tt0L	T0CKI Low Pulse Width		No Prescaler	0.5TCY + 20	—	—	ns	Must also meet parameter 42
				With Prescaler	10	—	—	ns	
42*	Tt0P	T0CKI Period		No Prescaler	TCY + 40	—	—	ns	N = prescale value (2, 4, ..., 256)
				With Prescaler	Greater of: 20 or $\frac{TCY + 40}{N}$	—	—	ns	
45*	Tt1H	T1CKI High Time	Synchronous, Prescaler = 1		0.5TCY + 20	—	—	ns	Must also meet parameter 47
			Synchronous, Prescaler = 2,4,8	PIC16C923/924	15	—	—	ns	
				PIC16LC923/924	25	—	—	ns	
			Asynchronous	PIC16C923/924	30	—	—	ns	
PIC16LC923/924	50	—		—	ns				
46*	Tt1L	T1CKI Low Time	Synchronous, Prescaler = 1		0.5TCY + 20	—	—	ns	Must also meet parameter 47
			Synchronous, Prescaler = 2,4,8	PIC16C923/924	15	—	—	ns	
				PIC16LC923/924	25	—	—	ns	
			Asynchronous	PIC16C923/924	30	—	—	ns	
PIC16LC923/924	50	—		—	ns				
47*	Tt1P	T1CKI input period	Synchronous	PIC16C923/924	Greater of: 30 OR $\frac{TCY + 40}{N}$	—	—	ns	N = prescale value (1, 2, 4, 8)
				PIC16LC923/924	Greater of: 50 OR $\frac{TCY + 40}{N}$				N = prescale value (1, 2, 4, 8)
			Asynchronous	PIC16C923/924	60	—	—	ns	
				PIC16LC923/924	100	—	—	ns	
	Ft1	Timer1 oscillator input frequency range (oscillator enabled by setting bit T1OSCEN)			DC	—	200	kHz	
48	TCKEZtmr1	Delay from external clock edge to timer increment			2Tosc	—	7Tosc	—	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C9XX

TABLE 17-12:A/D CONVERTER CHARACTERISTICS:
PIC16C924-04 (COMMERCIAL, INDUSTRIAL)
PIC16LC924-04 (COMMERCIAL, INDUSTRIAL)

Param No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
A01	NR	Resolution	—	—	8-bits	bit	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A02	EABS	Total Absolute error	—	—	< ± 1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A03	EIL	Integral linearity error	—	—	< ± 1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A04	EDL	Differential linearity error	—	—	< ± 1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A05	EFS	Full scale error	—	—	< ± 1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A06	EOFF	Offset error	—	—	< ± 1	LSb	VREF = VDD = 5.12V, VSS ≤ VAIN ≤ VREF
A10	—	Monotonicity	—	guaranteed	—	—	VSS ≤ VAIN ≤ VREF
A20	VREF	Reference voltage	3.0V	—	VDD + 0.3	V	
A25	VAIN	Analog input voltage	VSS - 0.3	—	VREF + 0.3	V	
A30	ZAIN	Recommended impedance of analog voltage source	—	—	10.0	kΩ	
A40	IAD	A/D conversion current (VDD)	PIC16C924	—	180	—	Average current consumption when A/D is on. (Note 1)
			PIC16LC924	—	90	—	
A50	IREF	VREF input current (Note 2)	10	—	1000	μA	During VAIN acquisition. Based on differential of VHOLD to VAIN to charge CHOLD, see Section 12.1.
			—	—	10	μA	During A/D Conversion cycle

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: When A/D is off, it will not consume any current other than minor leakage current.

The power-down current spec includes any such leakage from the A/D module.

2: VREF current is from RA3 pin or VDD pin, whichever is selected as reference input.

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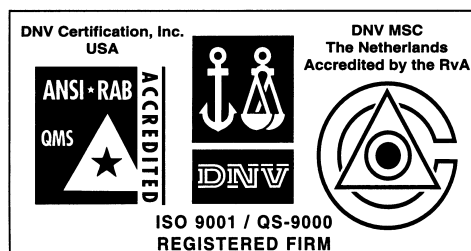
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